## Cool MOS ${ }^{\text {TM }}$ Power Transistor

## Feature

- New revolutionary high voltage technology

| $V_{\mathrm{DS}} @ T_{\text {jmax }}$ | 560 | V |
| :---: | :---: | :---: |
| $R_{\mathrm{DS}(\text { on })}$ | 0.19 | $\Omega$ |
| $I_{\mathrm{D}}$ | 21 | A |

- Ultra low gate charge
- Periodic avalanche rated
- Extreme dv/dt rated
- Ultra low effective capacitances
- Improved transconductance

PG-TO247


- Pb-free lead plating; RoHS compliant
- Qualified according to JEDEC ${ }^{0}$ for target applications

| Type | Package | Ordering Code | Marking |
| :--- | :--- | :--- | :--- |
| SPW21N50C3 | PG-TO247 | Q67040-S4586 | 21N50C3 |



## Maximum Ratings

| Parameter | Symbol | Value | Unit |
| :---: | :---: | :---: | :---: |
| Continuous drain current $\begin{aligned} & T_{\mathrm{C}}=25^{\circ} \mathrm{C} \\ & T_{\mathrm{C}}=100^{\circ} \mathrm{C} \end{aligned}$ | $I_{\text {D }}$ | $\begin{gathered} 21 \\ 13.1 \end{gathered}$ | A |
| Pulsed drain current, $t_{\mathrm{p}}$ limited by $T_{\text {jmax }}$ | $I_{\text {D puls }}$ | 63 |  |
| Avalanche energy, single pulse $I_{D}=10 \mathrm{~A}, V_{\mathrm{DD}}=50 \mathrm{~V}$ | $E_{\text {AS }}$ | 690 | mJ |
| Avalanche energy, repetitive $t_{\mathrm{AR}}$ limited by $T_{\text {jmax }}{ }^{1}$ $I_{\mathrm{D}}=21 \mathrm{~A}, V_{\mathrm{DD}}=50 \mathrm{~V}$ | $E_{\text {AR }}$ | 1 |  |
| Avalanche current, repetitive $t_{\text {AR }}$ limited by $T_{\text {jmax }}$ | $I_{\text {AR }}$ | 21 | A |
| Reverse diode dv/d $t^{4)}$ | $\mathrm{d} v / \mathrm{d} t$ | 15 | $\mathrm{V} / \mathrm{ns}$ |
| Gate source voltage | $V_{\mathrm{GS}}$ | $\pm 20$ | V |
| Gate source voltage AC ( $\mathrm{f}>1 \mathrm{~Hz}$ ) | $V_{\mathrm{GS}}$ | $\pm 30$ |  |
| Power dissipation, $T_{\mathrm{C}}=25^{\circ} \mathrm{C}$ | $P_{\text {tot }}$ | 208 | W |
| Operating and storage temperature | $T_{\mathrm{j}}, T_{\text {stg }}$ | $-55 \ldots+150$ | ${ }^{\circ} \mathrm{C}$ |

SPW21N50C3

## Maximum Ratings

| Parameter | Symbol | Value | Unit |
| :--- | :--- | :---: | :---: |
| Drain Source voltage slope | $\mathrm{d} v / \mathrm{d} t$ | 50 | $\mathrm{~V} / \mathrm{ns}$ |
| $V_{\mathrm{DS}}=400 \mathrm{~V}, I_{\mathrm{D}}=21 \mathrm{~A}, T_{\mathrm{j}}=125^{\circ} \mathrm{C}$ |  |  |  |

## Thermal Characteristics

| Parameter | Symbol | Values |  |  | Unit |
| :--- | :--- | :---: | :---: | :---: | :---: |
|  |  |  | min. | typ. | max. |
| Thermal resistance, junction - case | $R_{\text {thJC }}$ | - | - | 0.6 | K/W |
| Thermal resistance, junction - ambient, leaded | $R_{\text {thJA }}$ | - | - | 62 |  |
| Soldering temperature, wavesoldering <br> $1.6 \mathrm{~mm}(0.063$ in.) from case for 10s | $T_{\text {sold }}$ | - | - | 260 | ${ }^{\circ} \mathrm{C}$ |

Electrical Characteristics, at $T_{\mathrm{j}}=25^{\circ} \mathrm{C}$ unless otherwise specified

| Parameter | Symbol | Conditions | Values |  |  | Unit |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  |  | min. | typ. | max. |  |
| Drain-source breakdown voltage | $V_{(\mathrm{BR}) \mathrm{DSS}}$ | $V_{\mathrm{GS}}=0 \mathrm{~V}, I_{\mathrm{D}}=0.25 \mathrm{~mA}$ | 500 | - | - | V |
| Drain-Source avalanche breakdown voltage | $V_{\text {(BR)DS }}$ | $V_{G S}=0 \mathrm{~V}, I_{\mathrm{D}}=21 \mathrm{~A}$ | - | 600 | - |  |
| Gate threshold voltage | $V_{\mathrm{GS}}(\mathrm{th})$ | $I_{D}=1000 \mu \mathrm{~A}, V_{\mathrm{GS}}=V_{\mathrm{DS}}$ | 2.1 | 3 | 3.9 |  |
| Zero gate voltage drain current | $I_{\text {DSS }}$ | $\begin{aligned} & V_{\mathrm{DS}}=500 \mathrm{~V}, V_{\mathrm{GS}}=0 \mathrm{~V}, \\ & T_{\mathrm{j}}=25^{\circ} \mathrm{C}, \\ & T_{\mathrm{j}}=150^{\circ} \mathrm{C} \end{aligned}$ | - | $0.1$ | $\begin{gathered} 1 \\ 100 \end{gathered}$ | $\mu \mathrm{A}$ |
| Gate-source leakage current | $I_{\text {GSS }}$ | $v_{\mathrm{GS}}=20 \mathrm{~V}, \mathrm{v}_{\mathrm{DS}}=0 \mathrm{~V}$ | - | - | 100 | nA |
| Drain-source on-state resistance | $R_{\text {DS(on) }}$ | $\begin{aligned} & V_{\mathrm{GS}}=10 \mathrm{~V}, I_{\mathrm{D}}=13.1 \mathrm{~A}, \\ & T_{\mathrm{j}}=25^{\circ} \mathrm{C} \\ & T_{\mathrm{j}}=150^{\circ} \mathrm{C} \end{aligned}$ |  | $\begin{aligned} & 0.16 \\ & 0.54 \end{aligned}$ | $0.19$ | $\Omega$ |
| Gate input resistance | $R_{G}$ | $f=1 \mathrm{MHz}$, open Drain | - | 0.53 | - |  |

Electrical Characteristics, at $T_{\mathrm{j}}=25^{\circ} \mathrm{C}$, unless otherwise specified

| Parameter | Symbol | Conditions | Values |  |  | Unit |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  |  | min. | typ. | max. |  |
| Transconductance | $g_{\text {fs }}$ | $V_{\mathrm{DS}} \geq 2^{*} / \mathrm{D}^{*} R_{\mathrm{DS}}$ (on)max, $I_{\mathrm{D}}=13.1 \mathrm{~A}$ | - | 18 | - | S |
| Input capacitance | $C_{\text {iss }}$ | $\begin{aligned} & V_{\mathrm{GS}}=0 \mathrm{~V}, V_{\mathrm{DS}}=25 \mathrm{~V}, \\ & f=1 \mathrm{MHz} \end{aligned}$ | - | 2400 | - | pF |
| Output capacitance | $C_{\text {oss }}$ |  | - | 1200 | - |  |
| Reverse transfer capacitance | $C_{\text {rss }}$ |  | - | 30 | - |  |
| Effective output capacitance,2) energy related | $C_{\text {o(er) }}$ | $\begin{aligned} & V_{\mathrm{GS}}=0 \mathrm{~V}, \\ & V_{\mathrm{DS}}=0 \mathrm{~V} \text { to } 400 \mathrm{~V} \end{aligned}$ | - | 87 | - | pF |
| Effective output capacitance, ${ }^{3)}$ time related | $C_{\text {o(tr) }}$ |  | - | tbd | - |  |
| Turn-on delay time | $t_{\text {d(on) }}$ | $\begin{aligned} & v_{\mathrm{DD}}=380 \mathrm{~V}, v_{\mathrm{GS}}=0 / 10 \mathrm{~V}, \\ & I_{\mathrm{D}}=21 \mathrm{~A}, R_{\mathrm{G}}=3.6 \Omega \end{aligned}$ | - | 10 | - | ns |
| Rise time | $t_{r}$ |  | - | 5 | - |  |
| Turn-off delay time | $t_{\text {d(off) }}$ |  | - | 67 | - |  |
| Fall time | $t_{f}$ |  | - | 4.5 | - |  |

## Gate Charge Characteristics

| Gate to source charge | $Q_{\mathrm{gs}}$ | $V_{D D}=380 \mathrm{~V}, I_{\text {d }}=21 \mathrm{~A}$ | - | 10 | - | nC |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| Gate to drain charge | $Q_{\mathrm{gd}}$ |  | - | 50 | - |  |
| Gate charge total | $Q_{\mathrm{g}}$ | $\begin{aligned} & V_{\mathrm{DD}}=380 \mathrm{~V}, I_{\mathrm{D}}=21 \mathrm{~A}, \\ & V_{\mathrm{GS}}=0 \text { to } 10 \mathrm{~V} \end{aligned}$ | - | 95 | - |  |
| Gate plateau voltage | $V_{\text {(plateau) }}$ | $V_{D D}=380 \mathrm{~V}, I_{\mathrm{D}}=21 \mathrm{~A}$ | - | 5 | - | V |

${ }^{0}$ J-STD20 and JESD22
${ }^{1}$ Repetitve avalanche causes additional power losses that can be calculated as $P_{\mathrm{AV}}=E_{\mathrm{AR}^{*}}{ }^{*}$.
${ }^{2} C_{\text {o(er) }}$ is a fixed capacitance that gives the same stored energy as $C_{\text {oss }}$ while $V_{D S}$ is rising from 0 to $80 \% V_{\text {DSs }}$.
${ }^{3} C_{\text {o(tr) }}$ is a fixed capacitance that gives the same charging time as $C_{\text {oss }}$ while $V_{D S}$ is rising from 0 to $80 \% V_{\text {DSS }}$.
${ }^{4} I_{\mathrm{SD}}<=I_{\mathrm{D}}$, di/dt<=200A/us, $\mathrm{V}_{\mathrm{DClink}}=400 \mathrm{~V}, \mathrm{~V}_{\text {peak }}<\mathrm{V}_{\mathrm{BR}, \mathrm{DSS}}, \mathrm{T}_{\mathrm{j}}<T_{\mathrm{j}, \text { max }}$.
Identical low-side and high-side switch.

SPW21N50C3

Electrical Characteristics, at $T_{\mathrm{j}}=25^{\circ} \mathrm{C}$, unless otherwise specified

| Parameter | Symbol | Conditions | Values |  |  | Unit |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  |  | min. | typ. | max. |  |
| Inverse diode continuous forward current | Is | $T_{C}=25^{\circ} \mathrm{C}$ | - | - | 21 | A |
| Inverse diode direct current, pulsed | ISM |  | - | - | 63 |  |
| Inverse diode forward voltage | $V_{\text {SD }}$ | $V_{\mathrm{GS}}=0 \mathrm{~V}, I_{\mathrm{F}}=I_{S}$ | - | 1 | 1.2 | V |
| Reverse recovery time | $t_{\text {rr }}$ | $\begin{aligned} & V_{\mathrm{R}}=380 \mathrm{~V}, I_{\mathrm{F}}=I_{\mathrm{S}}, \\ & \mathrm{~d} i_{\mathrm{F}} / \mathrm{d}=100 \mathrm{~A} / \mu \mathrm{s} \end{aligned}$ | - | 450 | - | ns |
| Reverse recovery charge | $Q_{\text {rr }}$ |  | - | 9 | - | $\mu \mathrm{C}$ |
| Peak reverse recovery current | $I_{\text {rrm }}$ |  | - | 60 | - | A |
| Peak rate of fall of reverse recovery current | $d i_{\mathrm{rr}} / d t$ |  | - | 1200 | - | A/ $/ \mathrm{s}$ |

## Typical Transient Thermal Characteristics

| Symbol | Value | Unit | Symbol | Value | Unit |
| :---: | :---: | :---: | :---: | :---: | :---: |
|  | typ. |  |  | typ. |  |
| Thermal resistance |  |  | Thermal capacitance |  |  |
| $R_{\text {th1 }}$ | 0.00769 | K/W | $\mathrm{C}_{\mathrm{th} 1}$ | 0.0003763 | Ws/K |
| $R_{\text {th2 }}$ | 0.015 |  | $\mathrm{C}_{\text {th2 }}$ | 0.001411 |  |
| $R_{\text {th3 }}$ | 0.029 |  | $\mathrm{C}_{\text {th3 }}$ | 0.001931 |  |
| $R_{\text {th4 }}$ | 0.114 |  | $\mathrm{C}_{\text {th4 }}$ | 0.005297 |  |
| $R_{\text {th5 }}$ | 0.136 |  | $\mathrm{C}_{\text {th5 }}$ | 0.012 |  |
| $R_{\text {th6 }}$ | 0.059 |  | $C_{\text {th6 }}$ | 0.091 |  |



1 Power dissipation
$P_{\text {tot }}=f\left(T_{\mathrm{C}}\right)$


3 Transient thermal impedance
$Z_{\text {thJC }}=f\left(t_{\mathrm{p}}\right)$
parameter: $D=t_{p} / T$


## 2 Safe operating area

$I_{D}=f\left(V_{D S}\right)$
parameter: $D=0, T_{C}=25^{\circ} \mathrm{C}$


## 4 Typ. output characteristic

$I_{D}=f\left(V_{D S}\right) ; \quad T_{j}=25^{\circ} \mathrm{C}$
parameter: $t_{\mathrm{p}}=10 \mu \mathrm{~s}, V_{\mathrm{GS}}$


## infineon

5 Typ. output characteristic
$I_{D}=f\left(V_{D S}\right) ; T_{j}=150^{\circ} \mathrm{C}$
parameter: $t_{\mathrm{p}}=10 \mu \mathrm{~s}, V_{\mathrm{GS}}$


7 Drain-source on-state resistance
$R_{\text {DS(on) }}=f\left(T_{\mathrm{j}}\right)$
parameter : $I_{D}=13.1 \mathrm{~A}, V_{G S}=10 \mathrm{~V}$


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6 Typ. drain-source on resistance
$R_{\text {DS(on) }}=f\left(I_{D}\right)$
parameter: $T_{j}=150^{\circ} \mathrm{C}, V_{\mathrm{GS}}$


## 8 Typ. transfer characteristics

$I_{\mathrm{D}}=f\left(V_{\mathrm{GS}}\right) ; V_{\mathrm{DS}} \geq 2 \times I_{\mathrm{D}} \times R_{\mathrm{DS}(\text { (on) }} \max$ parameter: $t_{\mathrm{p}}=10 \mu \mathrm{~s}$


## 9 Typ. gate charge

$V_{\mathrm{GS}}=f\left(Q_{\text {Gate }}\right)$
parameter: $I_{D}=21 \mathrm{~A}$ pulsed


11 Avalanche SOA
$I_{\mathrm{AR}}=f\left(t_{\mathrm{AR}}\right)$
par.: $T_{j} \leq 150^{\circ} \mathrm{C}$


10 Forward characteristics of body diode
$I_{F}=f\left(V_{S D}\right)$
parameter: $T_{\mathrm{j}}, \mathrm{tp}=10 \mu \mathrm{~s}$


## 12 Avalanche energy

$E_{\text {AS }}=f\left(T_{\mathrm{j}}\right)$
par.: $I_{D}=10 \mathrm{~A}, V_{\mathrm{DD}}=50 \mathrm{~V}$


## 13 Drain-source breakdown voltage

$V_{(\mathrm{BR}) \mathrm{DSS}}=f\left(T_{\mathrm{j}}\right)$


15 Typ. capacitances
$C=f\left(V_{\mathrm{DS}}\right)$
parameter: $V_{\mathrm{GS}}=0 \mathrm{~V}, f=1 \mathrm{MHz}$


## 14 Avalanche power losses

$P_{\text {AR }}=f(f)$
parameter: $E_{A R}=1 \mathrm{~mJ}$


16 Typ. $C_{\text {oss }}$ stored energy
$E_{\mathrm{oss}}=f\left(V_{\mathrm{DS}}\right)$


Definition of diodes switching characteristics


PG-TO-247-3-1


| DIM | MILLIMETERS |  | INCHES |  |  |  |  |  |  |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  | MIN | MAX | MIN | MAX |  |  |  |  |  |
| A | 4.90 | 5.16 | 0.193 | 0.203 |  |  |  |  |  |
| A1 | 2.27 | 2.53 | 0.089 | 0.099 |  |  |  |  |  |
| A2 | 1.85 | 2.11 | 0.073 | 0.083 |  |  |  |  |  |
| b | 1.07 | 1.33 | 0.042 | 0.052 |  |  |  |  |  |
| b1 | 1.90 | 2.41 | 0.075 | 0.095 |  |  |  |  |  |
| b2 | 1.90 | 2.16 | 0.075 | 0.085 |  |  |  |  |  |
| b3 | 2.87 | 3.38 | 0.113 | 0.133 |  |  |  |  |  |
| b4 | 2.87 | 3.13 | 0.113 | 0.123 |  |  |  |  |  |
| c | 0.55 | 0.68 | 0.022 | 0.027 |  |  |  |  |  |
| D | 20.82 | 21.10 | 0.820 | 0.831 |  |  |  |  |  |
| D1 | 16.25 | 17.65 | 0.640 | 0.695 |  |  |  |  |  |
| D2 | 1.05 | 1.35 | 0.041 | 0.053 |  |  |  |  |  |
| E | 15.70 | 16.03 | 0.618 | 0.631 |  |  |  |  |  |
| E1 | 13.10 | 14.15 | 0.516 | 0.557 |  |  |  |  |  |
| E2 | 3.68 | 5.10 | 0.145 | 0.201 |  |  |  |  |  |
| E3 | 1.68 | 2.60 | 0.066 | 0.102 |  |  |  |  |  |
| e |  |  |  | 0.214 |  |  |  |  |  |
| N |  |  |  |  |  | 3 |  | 0.780 | 0.799 |
| L | 19.80 | 20.31 | 0.164 | 0.176 |  |  |  |  |  |
| L1 | 4.17 | 3.50 | 3.70 | 0.138 |  |  |  |  |  |
| øP | 3.49 | 6.00 | 0.216 | 0.146 |  |  |  |  |  |
| Q | 6.04 | 6.30 | 0.238 | 0.248 |  |  |  |  |  |
| S |  |  |  |  |  |  |  |  |  |


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## 1 New package outlines TO-247

Assembly capacity extension for CoolMOSTM technology products assembled in lead-free package PG-TO247-3 at subcontractor ASE (Weihai) Inc., China (Changes are marked in blue.)


Figure 1 Outlines TO-247, dimensions in mm/inches

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